

# MA27V23

Silicon epitaxial planar type

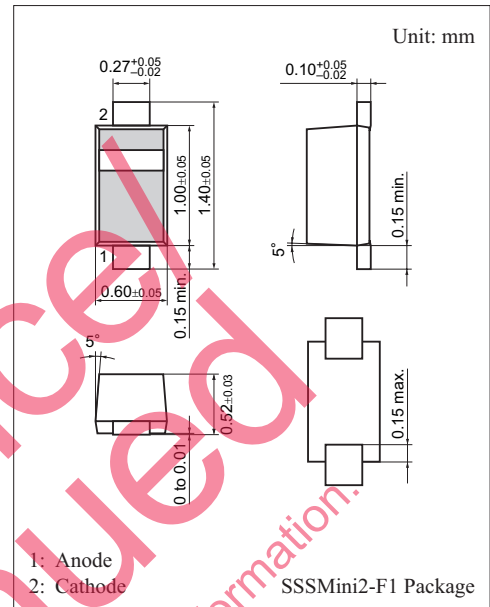
For VCO

■ Features

- Good linearity and large capacitance-ratio in  $C_D - V_R$  relation
- Low series resistance  $r_D$

■ Absolute Maximum Ratings  $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	6	V
Junction temperature	$T_j$	125	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-55 to +125	$^\circ\text{C}$



1: Anode  
2: Cathode  
SSSMini2-F1 Package

Marking Symbol: Y

■ Electrical Characteristics  $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current	$I_R$	$V_R = 5\text{ V}$			10	nA
Diode capacitance	$C_{D(1V)}$	$V_R = 1\text{ V}, f = 1\text{ MHz}$	2.28		2.46	pF
	$C_{D(4V)}$	$V_R = 4\text{ V}, f = 1\text{ MHz}$	1.00		1.10	
Capacitance ratio	$C_{D(1V)} / C_{D(4V)}$		2.17		2.34	—
Series resistance *	$r_D$	$V_R = 4\text{ V}, f = 470\text{ MHz}$			0.35	$\Omega$

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Absolute frequency of input and output is 470 MHz

3. \*: Measuring instrument: YHP 4191A RF IMPEDANCE ANALYZER

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